

PDS8



Five Band 3G HSPA



Bearer Independent Protocol



Multi Design Capability (LGA)



Java embedded



USB 2.0 High Speed compatible



Advanced Temperature Management



Embedded TCP/IP Stack



RLS Monitoring (Jamming Detection)



FOTA configurable & free of charge



GPS



3G

Cinterion® PDS8 Wireless Module
Global 3G with Java™ embedded and GPS

Cinterion® PDS8 Wireless Module Global 3G with Java™ Embedded and GPS

For more than a decade, Gemalto's Java strategy has enabled customers and partners to leverage the massive Java ecosystem by offering a powerful ARM11 architecture to reduce complexity and speed application integration.

Gemalto is expanding its leading edge portfolio of Java embedded solutions and services with the Cinterion® PDS8, an embedded GPS machine-to-machine (M2M) module.

The compact PDS8 module offers the latest Java ME 3.2 client runtime platform optimized for resource-constrained M2M applications. It significantly reduces total cost of ownership (TCO) and development timelines by sharing internal resources such as memory, a large existing code base and proven software building blocks. The improved Java concept uses Multi MIDlet Java execution to simultaneously host and run multiple applications and protocols. An extended security concept with the latest TLS/SSL engine provides secure and reliable TCP/IP connectivity while an enriched internal flash file system enables royalty free firmware updates over-the-air (FOTA) when required.

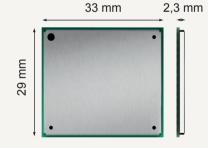
Sophisticated sandbox modeling and layered architectures

simplify device management (DM) and separate mobile network operator approvals from application code development, allowing simultaneous progress of both phases for a shorter time to market.

Providing the capability for multiple designs from one solution, the newest addition to Gemalto M2M's Evolution platform is an ideal module for applications migrating from 2G to 3G requiring cost efficiency along with global connectivity. PDS8 offers five band HSPA to support high bandwidth connectivity and enables speeds up to 7.2 Mbps in downlink and 5.7 Mbps in uplink. The module's ultra compact design incorporates minimal power consumption, optimized heat dissipation even under harsh operating conditions and an extended product lifecycle to guarantee long product availability. PDS8 supports common industrial interfaces such as USB, serial interfaces, I²C and various GPIO's to be connected with the Java engine.

Bringing together embedded GPS, a miniaturized footprint and cost efficiency with Java flexibility and 3G capabilities, the PDS8 module is the ideal solution for size-constrained applications such as track and trace solutions.

Global 3G with Java™ Embedded and GPS



LGA technology

Land grid array, or LGA, is a surface-mount technology for fully automated manufacturing allowing to benefit from efficiency and process consistency. Gemalto M2M's unique type of LGA technology is designed with focus on highest reliability and flexibility and to meet the demanding requirements of M2M application manufacturers.

Full type approval

As is true with all Cinterion modules, PDS8 includes full type approval (FTA) for

global roaming as well as certification from the largest mobile operators worldwide.

Java™

Java offers easy and fast application development, a broad choice of tools, high code reusability, easy maintenance, a proven security concept, on-device debugging as well as multi-threading programming and program execution.

Gemalto M2M Support includes:

- > Personal design-in consulting for hardware and software
- > Extensive RF test capabilities
- > GCF/PTCRB conform pretests to validate approval readiness
- > Regular training workshops



Local engineers, a competent helpdesk, a dedicated team of R&D specialists and an advanced development center are the hallmarks of our leading support offer.

Cinterion® PDS8 Features

GENERAL FEATURES

- > 3GPP Rel.7 Compliant Protocol Stack
- > Five Bands UMTS (WCDMA/FDD) Bands: 800, 850, 900, 1900 and 2100 MHz
- > Quad-Band GSM Bands: 850, 900, 1800 and 1900 MHz
- > SIM Application Toolkit, letter class "b", "c", "e" with BIP and RunAT support
- > Control via standardized and extended ATcommands (Hayes, TS 27.007 and 27.005)
- > Embedded IP stack with IPv4 and IPv6 support

- > TCP/IP stack access via AT command and transparent TCP/UDP services
- > Secure Connection with TSL
- > Internet Services TCP/UDP server/client, DNS, Ping, HTTP client
- > LGA pad soldering mount, MSL4
- > Supply voltage range 3.3 4.5 V, highly optimized for minimal power consumption
- > Dimension: 29 x 33 x 2.3 mm
- > Weight: 3 g
- > Operating Temperature: -40 °C to +90 °C

SPECIFICATIONS

- > HSDPA Cat.8 / HSUPA Cat.6 data rates DL: max. 7.2 Mbps, UL: max. 5.76 Mbps
- > EDGE Class 12 data rates DL: max. 237 kbps, UL: max. 237 kbps
- > GPRS Class 12 data rates DL: max. 85.6 kbps, UL: max. 85.6 kbps

- > CSD data transmission up to 9.6 kbps
- > SMS text and PDU mode support
- > High quality voice support for handset, headset and hands-free operation
- > Integrated TTY modem

SPECIAL FEATURES

- > USB interface feature a composite mode, compliant to Windows, Linux and Mac
- > Firmware update via USB and serial interface
- > RLS Monitoring (Jamming detection)
- > Informal Network Scan
- > Option for embedded Secure Element (eSE)

JAVA OPEN PLATFORM

- > Java™ ME 3.2
- > Multi-Threading programming and Multi-Application execution
- > 6 MB RAM and 10 MB Flash File System

GPS FEATURES

- > Integrated 32 Channel GNSS receiver
- > NMEA-183, EGNOS, WAAS
- > Position Accuracy (CEP50): 1.5m
- > TTFF (-130dBm): 1s Hot Start, <35s Cold Start
- > Sensitivity (active antenna):
 - > Acquisition -145dBm,
 - > Navigation -156dBm,
 - > Tracking -162dBm

INTERFACES (LGA PADS)

- > Power Supply
- > Pad for GSM/WCDMA Antenna
- > Pad for AGPS Antenna
- > USB 2.0 HS interface up to 480 Mbps
- > High speed serial modem interface ASC0 up to 921 khns
- > HSIC interface up to 480 Mbps

- > 16 GPIO lines shared with DSR, DTR, DCD (all ASCO), ASC1 (RXD, TXD, RTS, CTS), SPI, Fast-Shutdown, Network-Status-Indication, PWM and Pulse-Counter lines
- > ADC and I2C interface
- > Digital audio interface
- > UICC and U/SIM card interface 1.8 V / 3 V
- > Lines for Module-On and Reset

DRIVERS

- > USB, MUX driver for Microsoft® Windows XP™, Vista™ and 7™
- > RIL, USB driver for Microsoft® Windows Embedded Handheld $^{\text{TM}}$ >= 6.x
- > USB, MUX driver for Microsoft® Windows Embedded Compact TM >= 5.x

APPROVALS

- > R&TTE, GCF, CE, FCC, PTCRB, IC, UL
- > AT&T and other local approvals and provider certifications
- > EuP, RoHS and REACH compliant

For more information, please visit

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